UCSB Production Status (8 assemblies)

Completed:

2 sextants
1 layer 3 module
HDFAs for sextant #3

On hand:

All but one DFA (need replacement 2 forward)
22 H1s (though H1-33 may be unusable)
11 H2s

Expecting:

6 “blobbed bond” H1s back
4 additional H1s for 7th, 8th sextants (H1-33? H1-79?)
2 “blobbed bond” H2s back
3 additional H2s for 7th, 8th modules

Worries:

Have had trouble making layer 2 forward HDI bonds
D03B-11 has twice refused briefly to ramp up;
D03B-10 is drawing 45+ μA (we have a replacement 3B)
H1-33has an apparently loose Berg connector

Schedule:

Gluing, Bonding, Testing are about a week ahead
Module assembly is on schedule
but
Need more H1s to keep pipeline full
Have been working on H2s in the meantime
Projected 6 sextants done by 4 December 98
    Likely to slip without new H1s soon
Projected 6 layer 3 modules by 1 January 99
    Likely to be early without new H1s